----- KWIC -----

## **BSPR**:

According to this invention a variety of substrates are provided such as insulative substrates, boards for circuits, electrically conductive circuit boards, electrically resistant circuit boards, multi-layer circuit boards, hybrid circuit boards, mounting circuit boards and a variety of electrical elements obtained by using a composition comprising an aromatic polyamide-imide

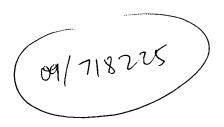
<u>as an electrically conductive</u> material, an electrically resistant material, a dielectric or insulative material, a protective material or a bonding material.

## **BSPR**:

The term "electrical element" used herein denotes an IC, a passive element, an

active element and a conversion element, such as a monolithic IC, a hybrid IC,

a resistor, a condenser, a coil, a diode, a transistor, a galvanomagnetic element, a photoelectric element, thermoelectric element, a piezoelectric element and a <u>display</u> element.



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